Supply of SBC 2GB RAM 16GB eMMC Development Board with 5.0 TOPS NPU (3 nos.)

Reference Order No.: iSenS/MLP2030/2023-24/DP 7

- 1. The order should not be preferably split. The comprehensive quote considering fabrication/fitment of all components, for at CSIO will be considered.
- 2. The required quantity is mentioned against each component in annexure 1. The components should be sealed /packed as per the original factory packing. If found damaged, will be returned.
- 3. The price should be including ex-CSIO delivery.
- 4. The valid coc/inspection report should be shared wherever applicable.
- 5. The supplier should share the authorization letter from the OEM, wherever applicable.
- 5. Payment and other things as per CSIO norms.
- 6. Pl mail at spo@csio.res.in and aashish_garv@csio.res.in
- 7. Quote time by 10:00 AM on 14.03.2024.
- 8. The details of the user will not be shared.
- 9. Supplier to share the delivery timelines after PO and payment terms. Release of PO is purely the prerogative of CSIO.
- 10. Material to be supplied on or before March 15, 2024

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Specifications

- 1. Amlogic A311D x4 2.2Ghz Cortex A73, x2 1.8Ghz Cortex A53
- 2. On board WIFI & Bluetooth
- 3. NPU: Supports a maximum frequency of 800MHz at 5.0 TOPS
- 4. 40 Pin GPIO Header (USB, I2C, I2S, UART, ADC etc)
- 5. Speed: 2.2GHz